

Freeform Search

Database:	US Patents Full-Text Database US Pre-Grant Publication Full-Text Database JPO Abstracts Database EPO Abstracts Database Derwent World Patents Index IBM Technical Disclosure Bulletins
Term:	(decapsulat\$3 near5 fluid) same (integrated circuit package or "IC")
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DB Name	Query	<u>Hit</u> Count	<u>Set</u> <u>Name</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(decapsulat\$3 near5 fluid) same (integrated circuit package or "IC")	2	<u>L5</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	11 and (circuit board)	1	<u>L4</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	l2 not l1	6	<u>L3</u>
USPT,PGPB,JPAB,EPAB,DWPI,TDBD	(decapsulat\$3 or remov\$3 near3 encapsulat%4) same (integrated circuit package or "IC")	17	<u>L2</u>
USPT,PGPB	(decapsulat\$3 or remov\$3 near3 encapsulat%4) same (integrated circuit package or "IC")	11	<u>L1</u>